

# NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

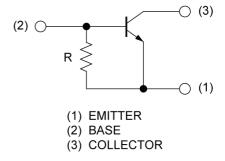
Parameter	Value		
V <sub>CEO</sub>	50V		
I <sub>C</sub>	100mA		
R	22kΩ		

# ● Outline SOT-323 SC-70 (2) (1) (UMT3)

## Features

1) Built-In Biasing Resistors, R =  $22k\Omega$ 

## •Inner circuit



## Application

INVERTER, INTERFACE, DRIVER

# Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC124GUA	SOT-323 (UMT3)	2021	T106	180	8	3000	K25

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	50	V
Collector-emitter voltage	$V_{CEO}$	50	V
Emitter-base voltage	$V_{EBO}$	5	V
Collector current	I <sub>C</sub>	100	mA
Power dissipation	P <sub>D</sub> *1	200	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Downwater	Cymah al	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 50μA	50	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 330μA	5	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	1	500	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	140	1	260	μA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0.5mA	-	-	300	mV
DC current gain	$h_{FE}$	$V_{CE} = 5V, I_{C} = 5mA$	56	-	-	-
Emitter-base resistance	R	-	15.4	22	28.6	kΩ
Transition frequency	f <sub>T</sub> *2	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Each terminal mounted on a reference land.

<sup>\*2</sup> Characteristics of built-in transistor

# ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Grounded emitter propagation characteristics

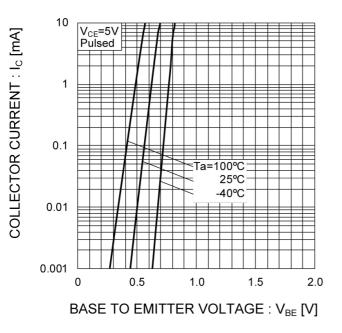
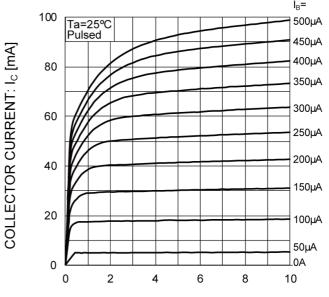


Fig.2 Grounded emitter output characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current gain vs. Collector Current

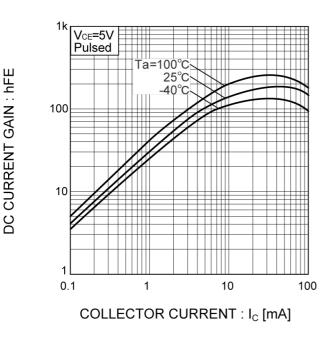
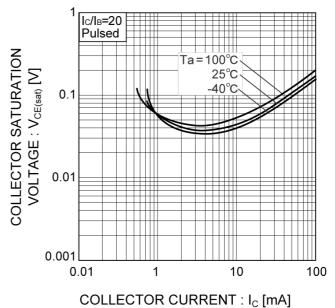
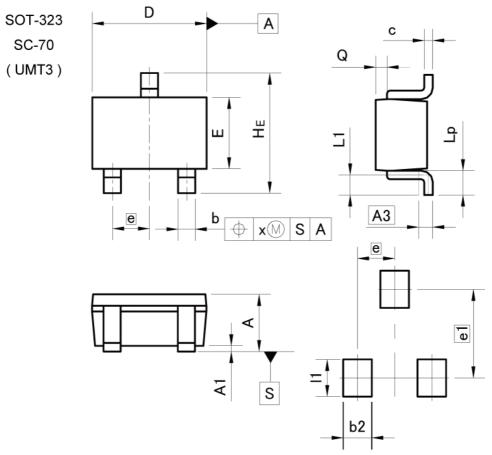


Fig.4 Collector-emitter saturation voltage vs. Collector Current



## Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	0.80	1.00	0.031	0.039	
A1	0.00	0.10	0.000	0.004	
A3	0.5	25	0.0	10	
b	0.25	0.40	0.010	0.016	
С	0.10	0.20	0.004	0.008	
D	1.90	2.10	0.075	0.083	
E	1.15	1.35	0.045	0.053	
е	0.	65	0.0	26	
HE	2.00	2.20	0.079	0.087	
L1	0.10	0.40	0.004	0.016	
Lp	0.25	0.55	0.010	0.022	
Q	0.10	0.30	0.004	0.012	
X	-	0.10	-	0.004	

DIM	MILIM	ETERS	INCHES		
DIM	MIN MAX		MIN	MAX	
b2	_	0.50	_	0.020	
e1	1.55		0.0	61	
- 11	-	0.65	-	0.026	

Dimension in mm/inches

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CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
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  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
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